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Linear Voltage Regulators 3Pin 1.5A Adj Vltg Reg

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TEXAS INSTRUMENTS

LM317 3-Terminal Adjustable Regulator

1 Features

- Output voltage range adjustable from 1.25 V to 37 V
- Output current greater than 1.5 A
- Internal short-circuit current limiting
- Thermal overload protection
- Output safe-area compensation

2 Applications

- ATCA solutions
- DLP: 3D biometrics, hyperspectral imaging, optical networking, and spectroscopy
- DVR and DVS
- Desktop PCs
- Digital signage and still cameras
- ECG electrocardiograms
- EV HEV chargers: levels 1, 2, and 3
- Electronic shelf labels
- Energy harvesting
- Ethernet switches
- Femto base stations
- Fingerprint and iris biometrics
- HVAC: heating, ventilating, and air conditioning
- High-speed data acquisition and generation
- Hydraulic valves
- IP phones: wired and wireless
- Intelligent occupancy sensing
- Motor controls: brushed DC, brushless DC, low-voltage, permanent magnet, and stepper motors
- Point-to-point microwave backhauls
- Power bank solutions
- Power line communication modems
- Power over ethernet (PoE)
- Power quality meters
- Power substation controls
- Private branch exchanges (PBX)
- Programmable logic controllers
- RFID readers
- Refrigerators
- Signal or waveform generators
- Software-defined radios (SDR)
- Washing machines: high-end and low-end
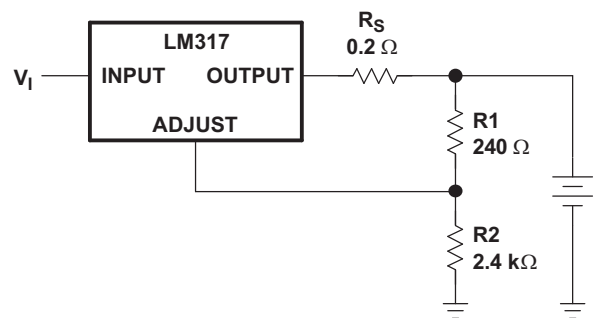- X-rays: baggage scanners, medical, and dental

3 Description

The LM317 device is an adjustable three-terminal positive-voltage regulator capable of supplying more than 1.5 A over an output-voltage range of 1.25 V to 37 V. It requires only two external resistors to set the output voltage. The device features a typical line regulation of 0.01% and typical load regulation of 0.1%. It includes current limiting, thermal overload protection, and safe operating area protection. Overload protection remains functional even if the ADJUST terminal is disconnected.

Device Information[1]

PART NUMBER	PACKAGE	BODY SIZE (NOM)
LM317DCY	SOT-223 (4)	6.50 mm × 3.50 mm
LM317KCS	TO-220 (3)	10.16 mm × 9.15 mm
LM317KCT	TO-220 (3)	10.16 mm × 8.59 mm
LM317KTT	TO-263 (3)	10.16 mm × 9.01 mm

(1) For all available packages, see the orderable addendum at the end of the data sheet.

Battery-Charger Circuit

Table of Contents

4 Revision History

Changes from Revision X (September 2016) to Revision Y   **Page**

Changes from Revision W (January 2015) to Revision X   **Page**

Changes from Revision V (February 2013) to Revision W   **Page**

5   Device Comparison Table

I_{OUT}	PARAMETER	LM317	LM317-N	LM317A	LM317HV	UNIT
1.5 A	Input voltage range	4.25 - 40	4.25 - 40	4.25 - 40	4.25 - 60	V
	Load regulation accuracy	1.5	1.5	1	1.5	%
	PSRR (120 Hz)	64	80	80	65	dB
	Recommended operating temperature	0 to 125	0 to 125	–40 to 125	0 to 125	°C
	TO-220 (NDE) T_{JA}	23.5	23.2	23.3	23	°C/W
	TO-200 (KCT) T_{JA}	37.9	N/A	N/A		°C/W
	TO-252 T_{JA}	N/A	54	54		°C/W
	TO-263 T_{JA}	38	41	N/A		°C/W
	SOT-223 T_{JA}	66.8	59.6	59.6		°C/W
	TO-92 T_{JA}	N/A	186	186		°C/W
0.5 A		**LM317M**				
	Input voltage range	3.75 - 40				V
	Load regulation accuracy	1.5				%
	PSRR (120 Hz)	80				dB
	Recommended operating temperature	-40 - 125				°C
	SOT-223 T_{JA}	60.2				°C/W
	TO-252 T_{JA}	56.9				°C/W
0.1 A		**LM317L**	**LM317L-N**			
	Input voltage range	3.75 - 40	4.25 - 40			V
	Load regulation accuracy	1	1.5			%
	PSRR (120 Hz)	62	80			dB
	Recommended operating temperature	–40 to 125	–40 to 125			°C
	SOT-23 T_{JA}	167.8	N/A			°C/W
	SO-8 T_{JA}	N/A	165			°C/W
	DSBGA T_{JA}	N/A	290			°C/W
	TO-92 T_{JA}	N/A	180			°C/W

6 Pin Configuration and Functions

**DCY Package
3-Pin SOT-223
Top View**

ADJUST — 1
OUTPUT — 2   4 — OUTPUT
INPUT — 3

Not to scale

**KCS or KCT Package
3-Pin TO-220
Top View**

OUTPUT

3 — INPUT
2 — OUTPUT
1 — ADJUST

Not to scale

**KTT Package
3-Pin TO-263
Top View**

OUTPUT

3 — INPUT
2 — OUTPUT
1 — ADJUST

Not to scale
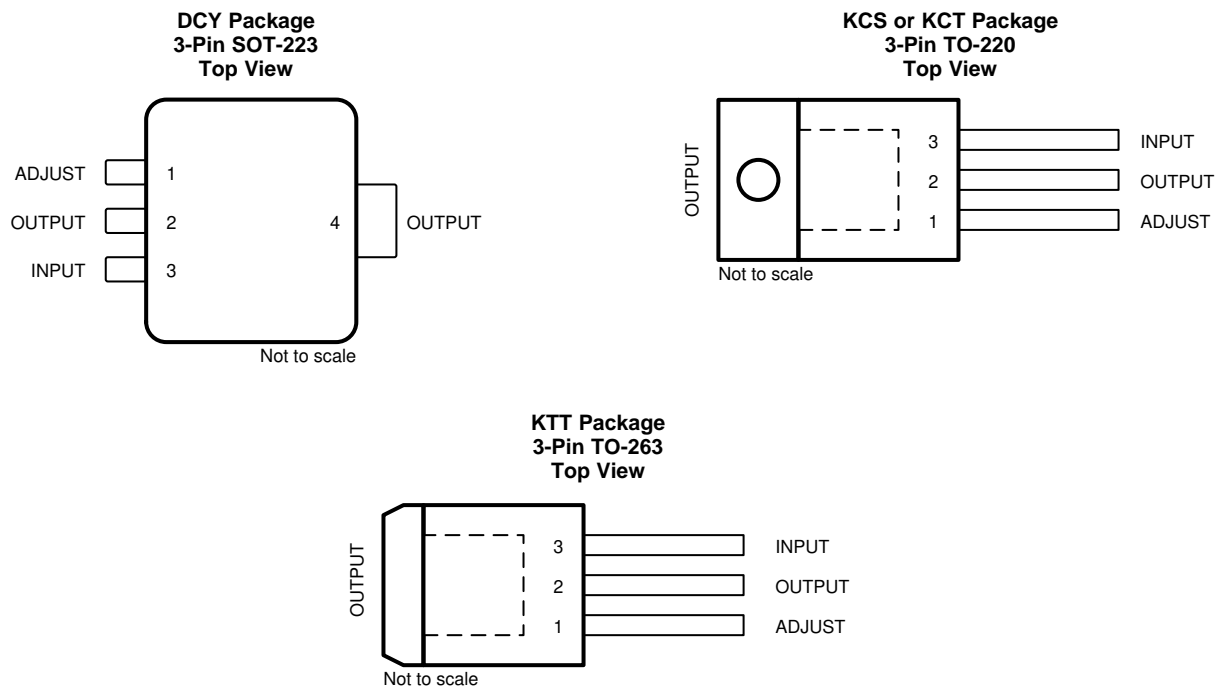
Pin Functions

PIN			I/O	DESCRIPTION
NAME	TO-263, TO-220	SOT-223		
ADJUST	1	1	I	Output voltage adjustment pin. Connect to a resistor divider to set V_O
INPUT	3	3	I	Supply input pin
OUTPUT	2	2, 4	O	Voltage output pin

Product Folder Links: *LM317*

7 Specifications

7.1 Absolute Maximum Ratings

over virtual junction temperature range (unless otherwise noted)[1]

		MIN	MAX	UNIT
$V_I - V_O$	Input-to-output differential voltage		40	V
T_J	Operating virtual junction temperature		150	°C
	Lead temperature 1,6 mm (1/16 in) from case for 10 s		260	°C
T_{stg}	Storage temperature	−65	150	°C

(1) Stresses beyond those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under *Recommended Operating Conditions* is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

7.2 ESD Ratings

			MAX	UNIT
$V_{(ESD)}$	Electrostatic discharge	Human body model (HBM), per ANSI/ESDA/JEDEC JS-001[1]	2500	V
		Charged device model (CDM), per JEDEC specification JESD22-C101[2]	1000	

(1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.
(2) JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.

7.3 Recommended Operating Conditions

		MIN	MAX	UNIT
V_O	Output voltage	1.25	37	V
$V_I - V_O$	Input-to-output differential voltage	3	40	V
I_O	Output current	0.01	1.5	A
T_J	Operating virtual junction temperature	0	125	°C

7.4 Thermal Information

THERMAL METRIC[1]		LM317				UNIT
		DCY (SOT-223)	KCS (TO-220)	KCT (TO-220)	KTT (TO-263)	
		4 PINS	3 PINS	3 PINS	3 PINS	
$R_{\theta(JA)}$	Junction-to-ambient thermal resistance	66.8	23.5	37.9	38.0	°C/W
$R_{\theta JC(top)}$	Junction-to-case (top) thermal resistance	43.2	15.9	51.1	36.5	°C/W
$R_{\theta JB}$	Junction-to-board thermal resistance	16.9	7.9	23.2	18.9	°C/W
ψ_{JT}	Junction-to-top characterization parameter	3.6	3.0	13.0	6.9	°C/W
ψ_{JB}	Junction-to-board characterization parameter	16.8	7.8	22.8	17.9	°C/W
$R_{\theta JC(bot)}$	Junction-to-case (bottom) thermal resistance	NA	0.1	4.2	1.1	°C/W

(1) For more information about traditional and new thermal metrics, see the *Semiconductor and IC package thermal metrics* application report.

7.5 Electrical Characteristics

over recommended ranges of operating virtual junction temperature (unless otherwise noted)

PARAMETER	TEST CONDITIONS[1]			MIN	TYP	MAX	UNIT
Line regulation[2]	$V_I - V_O$ = 3 V to 40 V		T_J = 25°C		0.01	0.04	%/V
			T_J = 0°C to 125°C		0.02	0.07	
Load regulation	I_O = 10 mA to 1500 mA	C_{ADJ}[3] = 10 µF, T_J = 25°C	$V_O \le$ 5 V			25	mV
			$V_O \ge$ 5 V		0.1	0.5	%V_O
		T_J = 0°C to 125°C	$V_O \le$ 5 V		20	70	mV
			$V_O \ge$ 5 V		0.3	1.5	%V_O
Thermal regulation	20-ms pulse, T_J = 25°C				0.03	0.07	%V_O/W
ADJUST terminal current					50	100	µA
Change in ADJUST terminal current	$V_I - V_O$ = 2.5 V to 40 V, $P_D \le$ 20 W, I_O = 10 mA to 1500 mA				0.2	5	µA
Reference voltage	$V_I - V_O$ = 3 V to 40 V, $P_D \le$ 20 W, I_O = 10 mA to 1500 mA			1.2	1.25	1.3	V
Output-voltage temperature stability	T_J = 0°C to 125°C				0.7		%V_O
Minimum load current to maintain regulation	$V_I - V_O$ = 40 V				3.5	10	mA
Maximum output current	$V_I - V_O \le$ 15 V, $P_D < P_{MAX}$[4]			1.5	2.2		A
	$V_I - V_O \le$ 40 V, $P_D < P_{MAX}$[4], T_J = 25°C			0.15	0.4		
RMS output noise voltage (% of V_O)	f = 10 Hz to 10 kHz, T_J = 25°C				0.003		%V_O
Ripple rejection	V_O = 10 V, f = 120 Hz	C_{ADJ} = 0 µF[3]			57		dB
		C_{ADJ} = 10 µF[3]		62	64		
Long-term stability	T_J = 25°C				0.3	1	%/1k hr

(1) Unless otherwise noted, the following test conditions apply: $|V_I - V_O|$ = 5 V and I_{OMAX} = 1.5 A, T_J = 0°C to 125°C. Pulse testing techniques are used to maintain the junction temperature as close to the ambient temperature as possible.
(2) Line regulation is expressed here as the percentage change in output voltage per 1-V change at the input.
(3) C_{ADJ} is connected between the ADJUST terminal and GND.
(4) Maximum power dissipation is a function of T_J(max), θ_{JA}, and T_A. The maximum allowable power dissipation at any allowable ambient temperature is P_D = (T_J(max) – T_A) / θ_{JA}. Operating at the absolute maximum T_J of 150°C can affect reliability.

7.6 Typical Characteristics

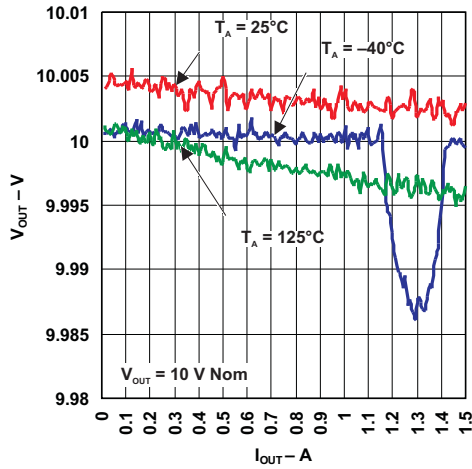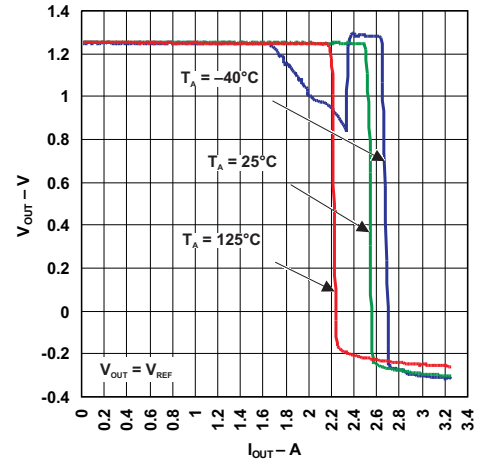**Figure 1. Load Regulation**

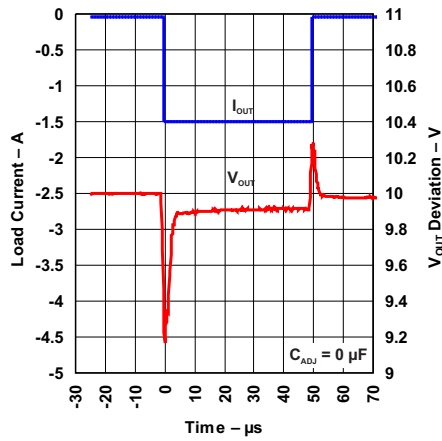
Figure 2. Load Regulation
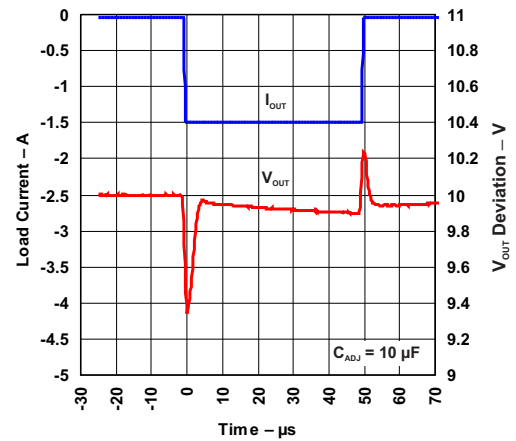

Figure 3. Load Transient Response

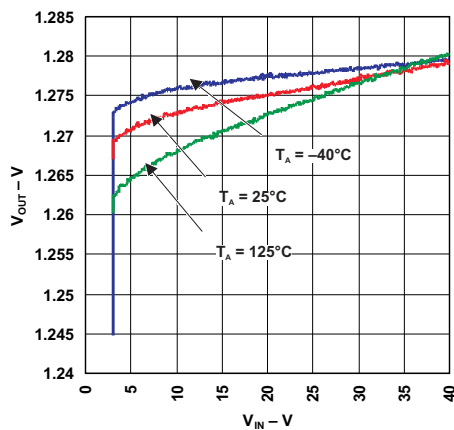**Figure 4. Load Transient Response**

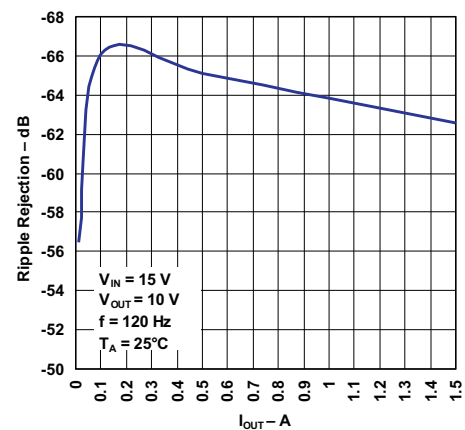**Figure 5. Line Regulation**

**Figure 6. Ripple Rejection
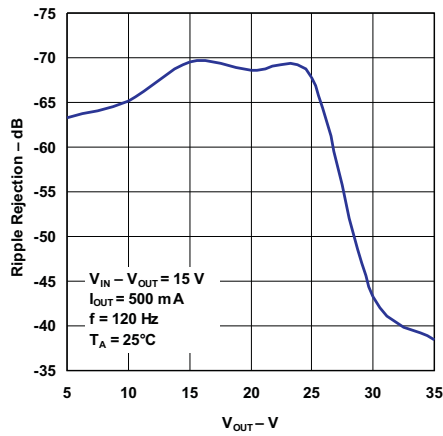vs Output Current**

Typical Characteristics (continued)

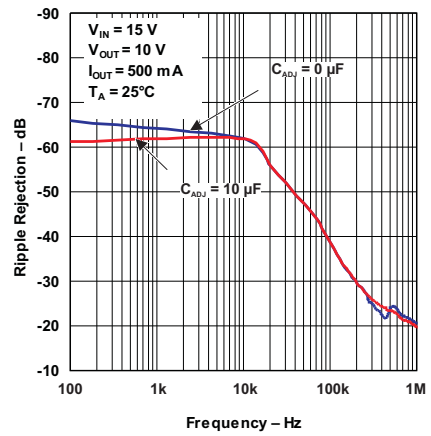
**Figure 7. Ripple Rejection
vs Output Voltage**

**Figure 8. Ripple Rejection
vs Frequency**

Product Folder Links: *LM317*

8 Detailed Description

8.1 Overview

The LM317 device is an adjustable three-terminal positive-voltage regulator capable of supplying up to 1.5 A over an output-voltage range of 1.25 V to 37 V. It requires only two external resistors to set the output voltage. The device features a typical line regulation of 0.01% and typical load regulation of 0.1%. It includes current limiting, thermal overload protection, and safe operating area protection. Overload protection remains functional even if the ADJUST terminal is disconnected.

The LM317 device is versatile in its applications, including uses in programmable output regulation and local on-card regulation. Or, by connecting a fixed resistor between the ADJUST and OUTPUT terminals, the LM317 device can function as a precision current regulator. An optional output capacitor can be added to improve transient response. The ADJUST terminal can be bypassed to achieve very high ripple-rejection ratios, which are difficult to achieve with standard three-terminal regulators.

8.2 Functional Block Diagram
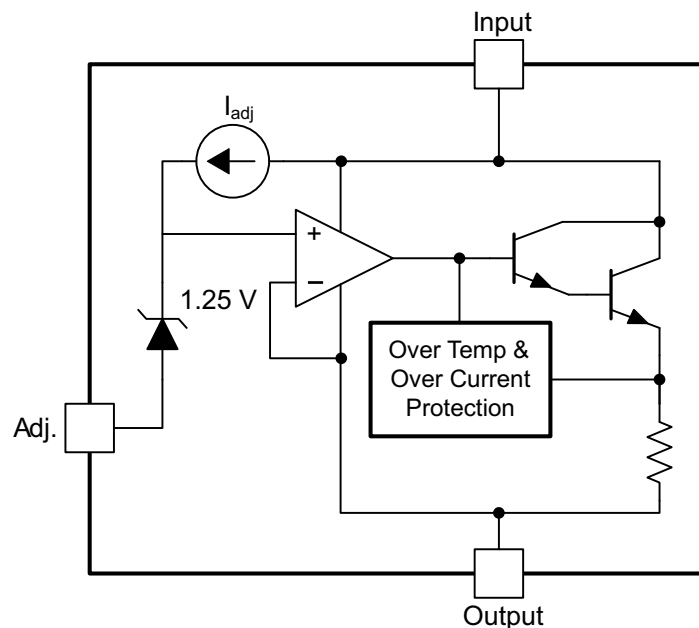
8.3 Feature Description

8.3.1 NPN Darlington Output Drive

NPN Darlington output topology provides naturally low output impedance and an output capacitor is optional. 3-V headroom is recommended ($V_I - V_O$) to support maximum current and lowest temperature.

8.3.2 Overload Block

Over-current and over-temperature shutdown protects the device against overload or damage from operating in excessive heat.

8.3.3 Programmable Feedback

Op amp with 1.25-V offset input at the ADJUST terminal provides easy output voltage or current (not both) programming. For current regulation applications, a single resistor whose resistance value is 1.25 V/I_O and power rating is greater than $(1.25 \text{ V})^2$/R should be used. For voltage regulation applications, two resistors set the output voltage.

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Product Folder Links: *LM317*

8.4 Device Functional Modes

8.4.1 Normal Operation

The device OUTPUT pin will source current necessary to make OUTPUT pin 1.25 V greater than ADJUST terminal to provide output regulation.

8.4.2 Operation With Low Input Voltage

The device requires up to 3-V headroom (V_I – V_O) to operate in regulation. The device may drop out and OUTPUT voltage will be INPUT voltage minus drop out voltage with less headroom.

8.4.3 Operation at Light Loads

The device passes its bias current to the OUTPUT pin. The load or feedback must consume this minimum current for regulation or the output may be too high. See the *Electrical Characteristics* table for the minimum load current needed to maintain regulation.

8.4.4 Operation In Self Protection

When an overload occurs the device shuts down Darlington NPN output stage or reduces the output current to prevent device damage. The device will automatically reset from the overload. The output may be reduced or alternate between on and off until the overload is removed.

9 Application and Implementation

> **NOTE**
>
> Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

9.1 Application Information

The flexibility of the LM317 allows it to be configured to take on many different functions in DC power applications.
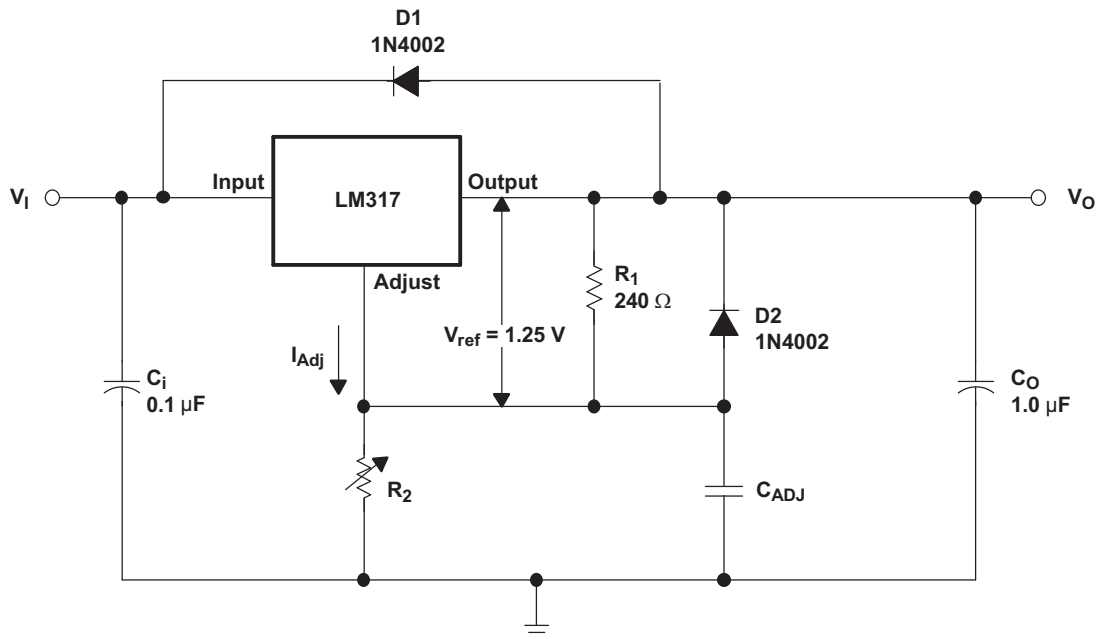
9.2 Typical Application

Figure 9. Adjustable Voltage Regulator

9.2.1 Design Requirements

- R1 and R2 are required to set the output voltage.
- C_{ADJ} is recommended to improve ripple rejection. It prevents amplification of the ripple as the output voltage is adjusted higher.
- C_i is recommended, particularly if the regulator is not in close proximity to the power-supply filter capacitors. A 0.1-µF or 1-µF ceramic or tantalum capacitor provides sufficient bypassing for most applications, especially when adjustment and output capacitors are used.
- C_O improves transient response, but is not needed for stability.
- Protection diode D2 is recommended if C_{ADJ} is used. The diode provides a low-impedance discharge path to prevent the capacitor from discharging into the output of the regulator.
- Protection diode D1 is recommended if C_O is used. The diode provides a low-impedance discharge path to prevent the capacitor from discharging into the output of the regulator.

9.2.2 Detailed Design Procedure

V_O is calculated as shown in Equation 1. I_{ADJ} is typically 50 µA and negligible in most applications.

$$V_O = V_{REF} (1 + R2 / R1) + (I_{ADJ} \times R2) \tag{1}$$

Typical Application (continued)

9.2.3 Application Curves
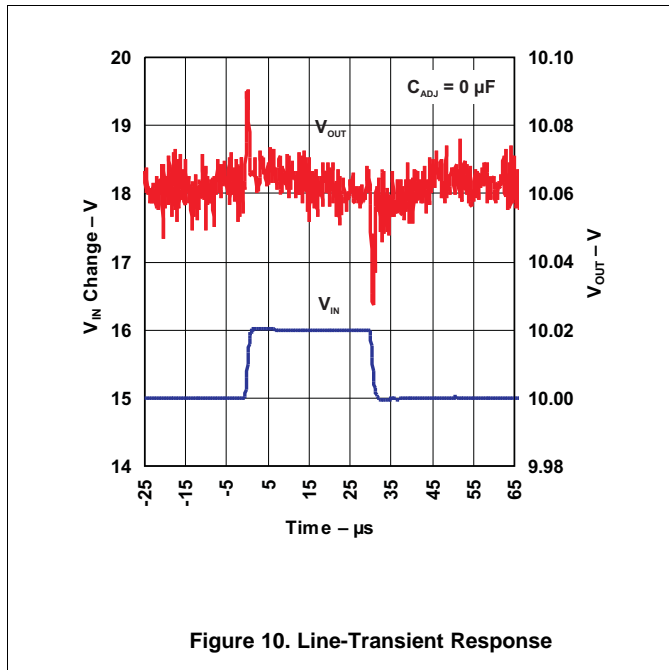
Figure 10. Line-Transient Response
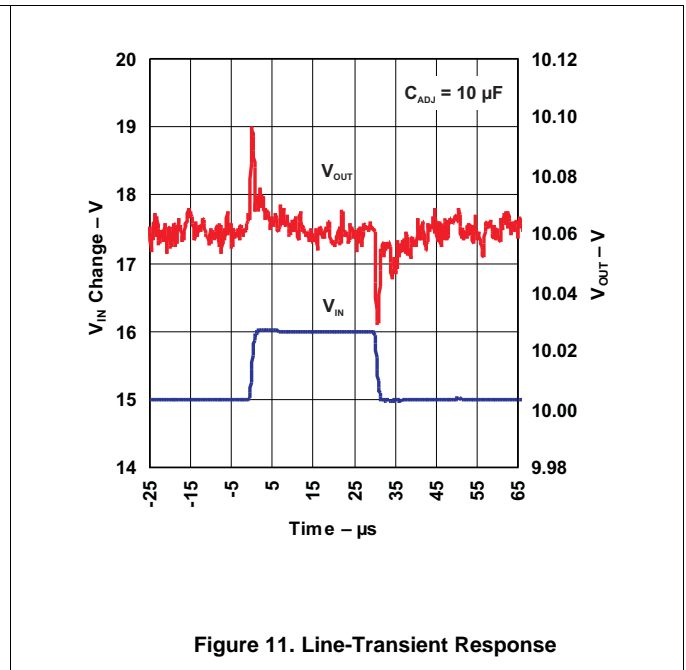
Figure 11. Line-Transient Response

9.3 System Examples

9.3.1 0-V to 30-V Regulator Circuit

Here, the voltage is determined by

$$V_{OUT} = V_{REF}\left(1 + \frac{R_2 + R_3}{R_1}\right) - 10\,V$$
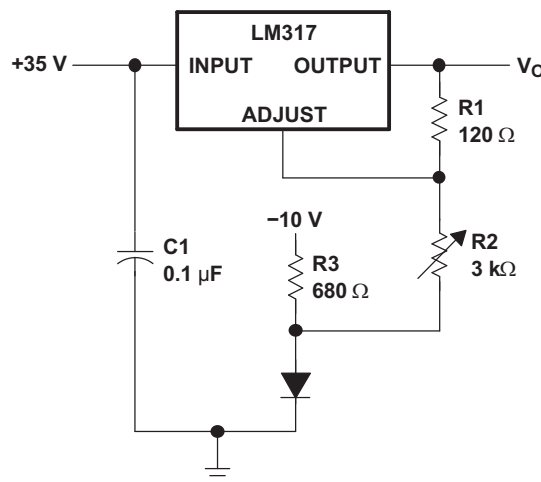
Figure 12. 0-V to 30-V Regulator Circuit

Product Folder Links: *LM317*

System Examples (continued)

9.3.2 Adjustable Regulator Circuit With Improved Ripple Rejection

C2 helps to stabilize the voltage at the adjustment pin, which helps reject noise. Diode D1 exists to discharge C2 in case the output is shorted to ground.
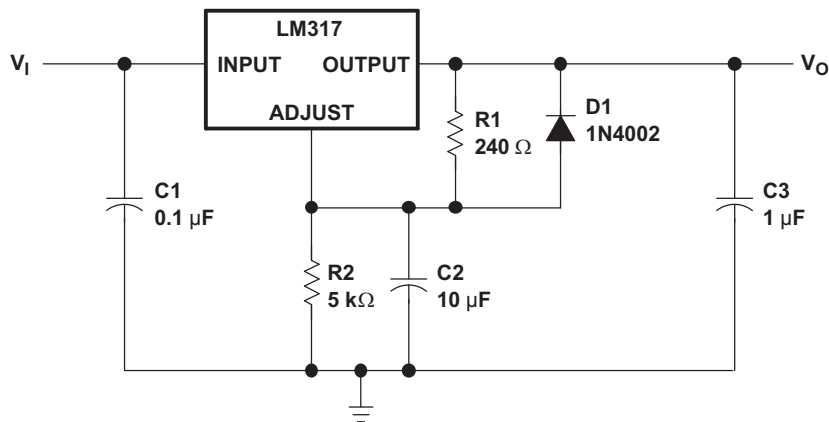
Figure 13. Adjustable Regulator Circuit with Improved Ripple Rejection

9.3.3 Precision Current-Limiter Circuit

This application limits the output current to the I_{LIMIT} in the diagram.
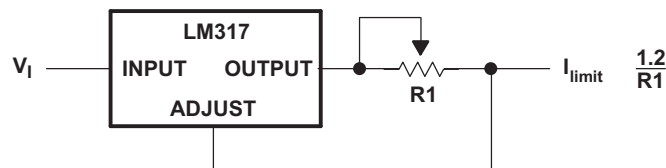
Figure 14. Precision Current-Limiter Circuit

9.3.4 Tracking Preregulator Circuit

This application keeps a constant voltage across the second LM317 in the circuit.
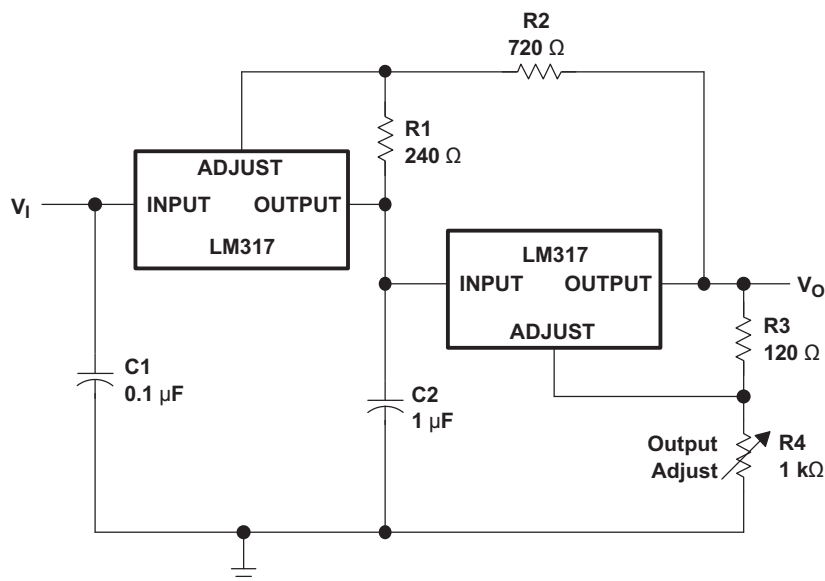
Figure 15. Tracking Preregulator Circuit

Product Folder Links: *LM317*

System Examples (continued)

9.3.5 1.25-V to 20-V Regulator Circuit With Minimum Program Current

Because the value of V_{REF} is constant, the value of R1 determines the amount of current that flows through R1 and R2. The size of R2 determines the IR drop from ADJUSTMENT to GND. Higher values of R2 translate to higher V_{OUT}.

$$V_{OUT} = V_{REF}\left(1 + \frac{R_2 + R_3}{R_1}\right) - 10\,V$$

(2)

$$(R1 + R2)min = VoI_{reg(min)}$$

(3)
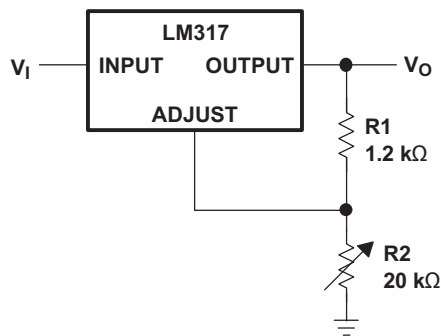
Figure 16. 1.25-V to 20-V Regulator Circuit With Minimum Program Current

9.3.6 Battery-Charger Circuit

The series resistor limits the current output of the LM317, minimizing damage to the battery cell.

$$V_{OUT} = 1.25\,V \times \left(1 + \frac{R2}{R1}\right)$$

(4)

$$I_{OUT}(short) = \frac{1.25V}{RS}$$

(5)

$$Output\ Impedance = RS \times \left(1 + \frac{R2}{R1}\right)$$

(6)
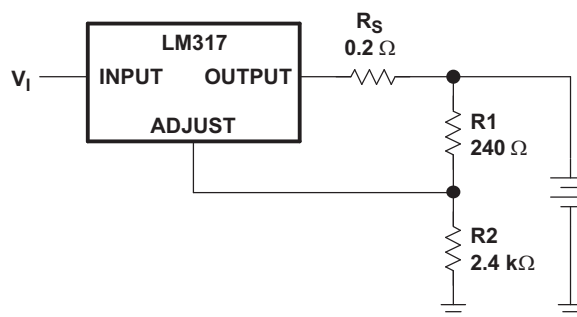
Figure 17. Battery-Charger Circuit

Product Folder Links: *LM317*

System Examples (continued)

9.3.7 50-mA Constant-Current Battery-Charger Circuit

The current limit operation mode can be used to trickle charge a battery at a fixed current. I_{CHG} = 1.25 V ÷ 24 Ω. V_I should be greater than V_{BAT} + 4.25 V. (1.25 V [V_{REF}] + 3 V [headroom])
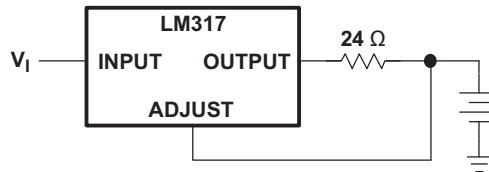
Figure 18. 50-mA Constant-Current Battery-Charger Circuit

9.3.8 Slow Turn-On 15-V Regulator Circuit

The capacitor C1, in combination with the PNP transistor, helps the circuit to slowly start supplying voltage. In the beginning, the capacitor is not charged. Therefore output voltage starts at V_{C1}+ V_{BE} + 1.25 V = 0 V + 0.65 V + 1.25 V = 1.9 V. As the capacitor voltage rises, V_{OUT} rises at the same rate. When the output voltage reaches the value determined by R1 and R2, the PNP will be turned off.
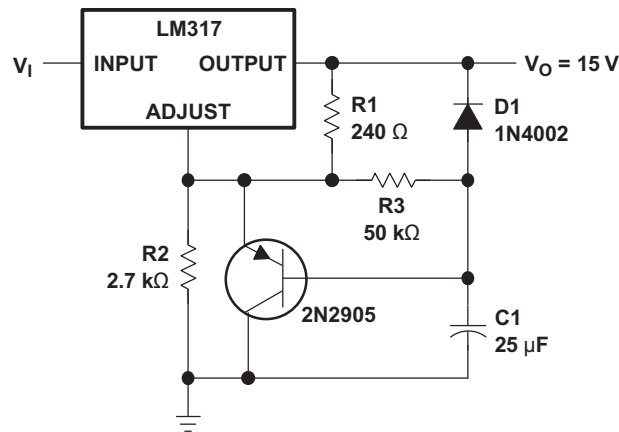
Figure 19. Slow Turn-On 15-V Regulator Circuit

9.3.9 AC Voltage-Regulator Circuit

These two LM317s can regulate both the positive and negative swings of a sinusoidal AC input.
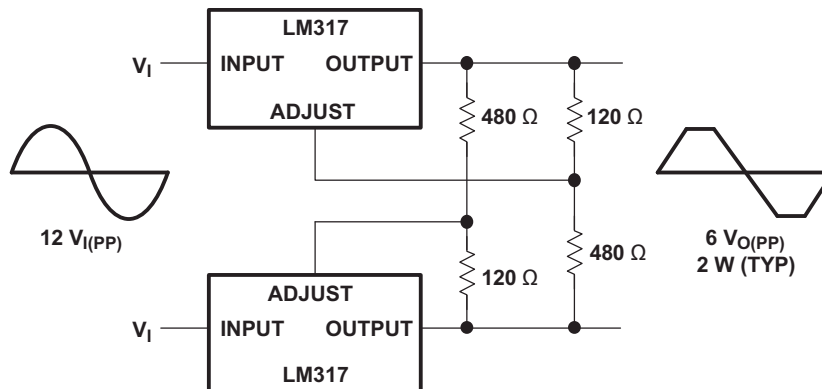
Figure 20. AC Voltage-Regulator Circuit

System Examples (continued)

9.3.10 Current-Limited 6-V Charger Circuit

As the charge current increases, the voltage at the bottom resistor increases until the NPN starts sinking current from the adjustment pin. The voltage at the adjustment pin drops, and consequently the output voltage decreases until the NPN stops conducting.
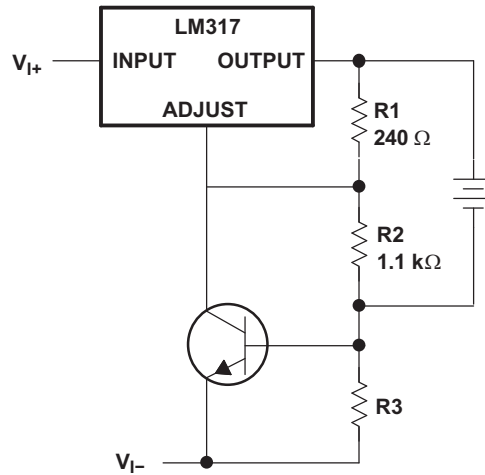
Figure 21. Current-Limited 6-V Charger Circuit

9.3.11 Adjustable 4-A Regulator Circuit

This application keeps the output current at 4 A while having the ability to adjust the output voltage using the adjustable (1.5 kΩ in schematic) resistor.
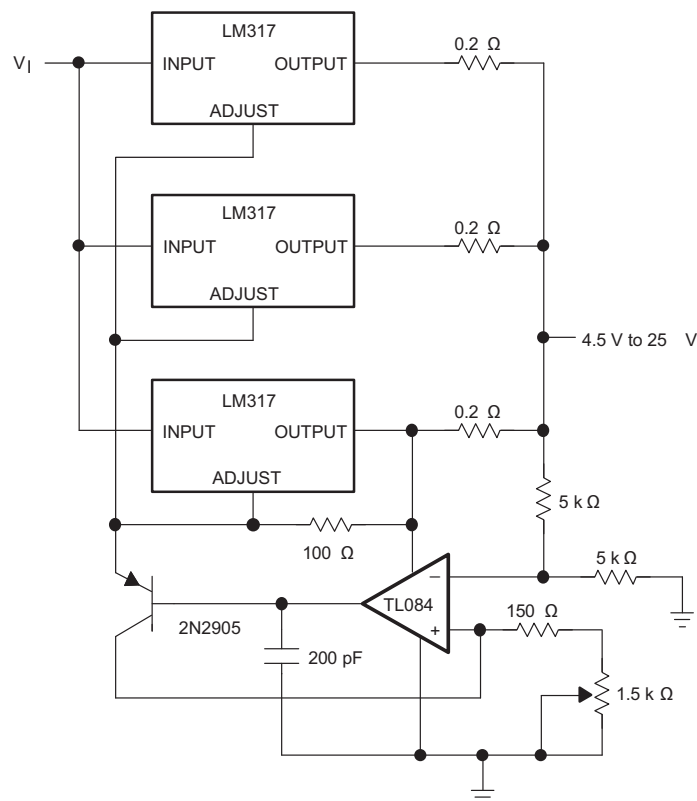
Figure 22. Adjustable 4-A Regulator Circuit

System Examples (continued)

9.3.12 High-Current Adjustable Regulator Circuit

The NPNs at the top of the schematic allow higher currents at V_{OUT} than the LM317 can provide, while still keeping the output voltage at levels determined by the adjustment pin resistor divider of the LM317.
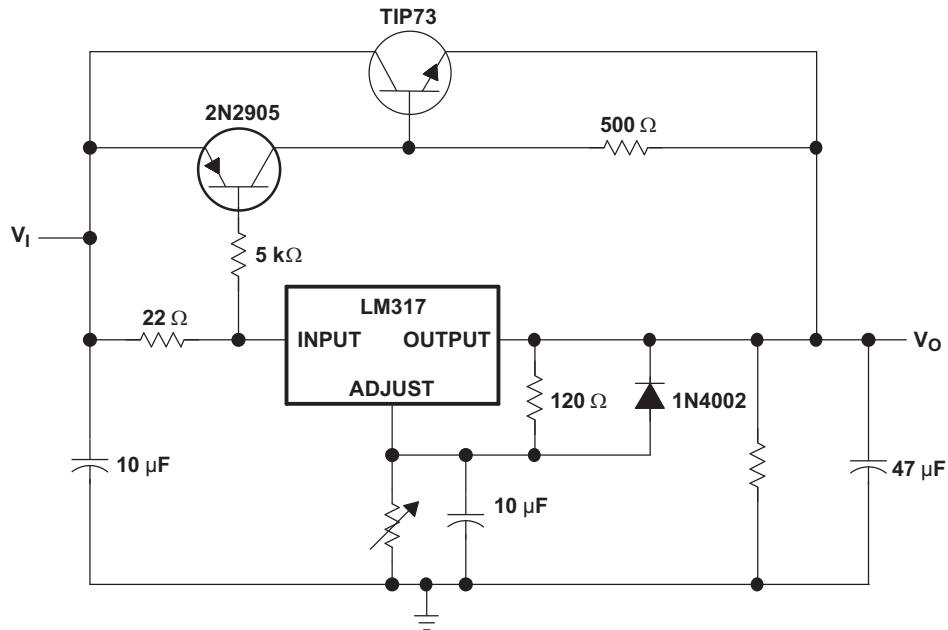
Figure 23. High-Current Adjustable Regulator Circuit

10 Power Supply Recommendations

The LM317 is designed to operate from an input voltage supply range between 1.25 V to 37 V greater than the output voltage. If the device is more than six inches from the input filter capacitors, an input bypass capacitor, 0.1 μF or greater, of any type is needed for stability.

11 Layout

11.1 Layout Guidelines

- TI recommends that the input terminal be bypassed to ground with a bypass capacitor.
- The optimum placement is closest to the input terminal of the device and the system GND. Take care to minimize the loop area formed by the bypass-capacitor connection, the input terminal, and the system GND.
- For operation at full rated load, TI recommends to use wide trace lengths to eliminate I × R drop and heat dissipation.

11.2 Layout Example
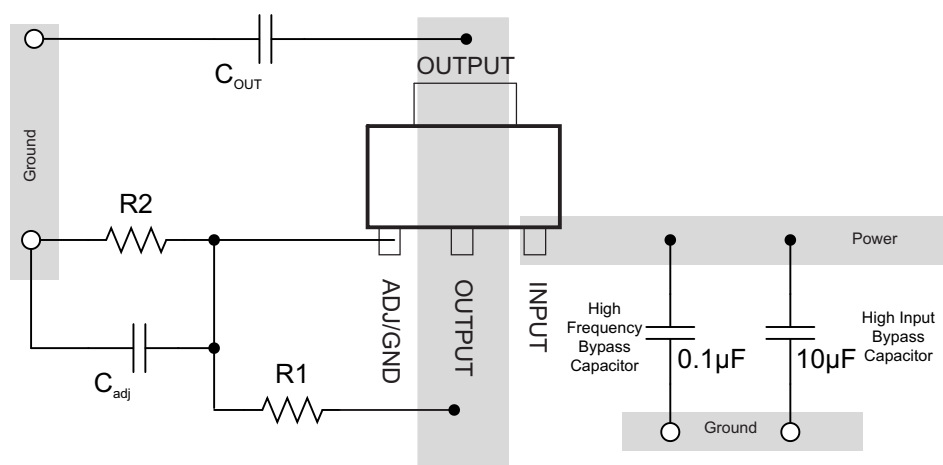
Figure 24. Layout Example

Product Folder Links: *LM317*

12 Device and Documentation Support

12.1 Receiving Notification of Documentation Updates

To receive notification of documentation updates, navigate to the device product folder on ti.com. In the upper right corner, click on *Alert me* to register and receive a weekly digest of any product information that has changed. For change details, review the revision history included in any revised document.

12.2 Support Resources

TI E2E™ support forums are an engineer's go-to source for fast, verified answers and design help — straight from the experts. Search existing answers or ask your own question to get the quick design help you need.

Linked content is provided "AS IS" by the respective contributors. They do not constitute TI specifications and do not necessarily reflect TI's views; see TI's Terms of Use.

12.3 Trademarks

E2E is a trademark of Texas Instruments.
All other trademarks are the property of their respective owners.

12.4 Electrostatic Discharge Caution

This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

12.5 Glossary

SLYZ022 — *TI Glossary*.
   This glossary lists and explains terms, acronyms, and definitions.

13 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead finish/ Ball material (6)	MSL Peak Temp (3)	O
LM317DCY	ACTIVE	SOT-223	DCY	4	80	RoHS & Green	SN	Level-2-260C-1 YEAR	
LM317DCYG3	ACTIVE	SOT-223	DCY	4	80	RoHS & Green	SN	Level-2-260C-1 YEAR	
LM317DCYR	ACTIVE	SOT-223	DCY	4	2500	RoHS & Green	SN	Level-2-260C-1 YEAR	
LM317DCYRG3	ACTIVE	SOT-223	DCY	4	2500	RoHS & Green	SN	Level-2-260C-1 YEAR	
LM317KCS	LIFEBUY	TO-220	KCS	3	50	RoHS & Green	SN	N / A for Pkg Type	
LM317KCSE3	LIFEBUY	TO-220	KCS	3	50	RoHS & Green	SN	N / A for Pkg Type	
LM317KTTR	ACTIVE	DDPAK/ TO-263	KTT	3	500	RoHS & Green	SN	Level-3-245C-168 HR	
LM317KTTRG3	ACTIVE	DDPAK/ TO-263	KTT	3	500	RoHS & Green	SN	Level-3-245C-168 HR	

(1) The marketing status values are defined as follows:
ACTIVE: Product device recommended for new designs.
LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.
NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.
PREVIEW: Device has been announced but is not in production. Samples may or may not be available.
OBSOLETE: TI has discontinued the production of the device.

(2) **RoHS:** TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including t
do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in sp
reference these types of products as "Pb-Free".
RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.
Green: TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm
flame retardants must also meet the <=1000ppm threshold requirement.

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a li
of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/B lines if the finish value exceeds the maximum column width.

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In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer o

PACKAGE MATERIALS INFORMATION

TAPE AND REEL INFORMATION

REEL DIMENSIONS

TAPE DIMENSIONS

A0	Dimension designed to accommodate the component width
B0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers
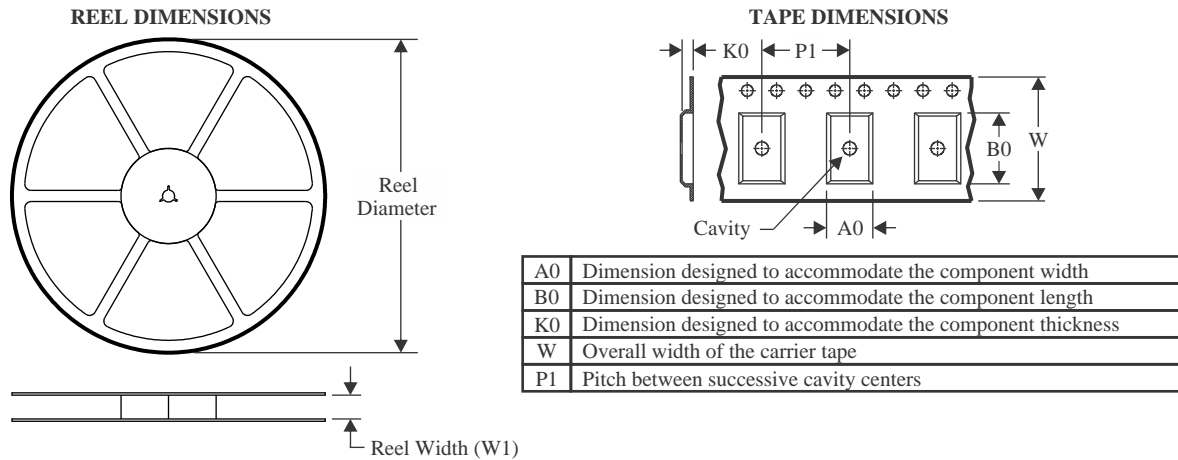
QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE
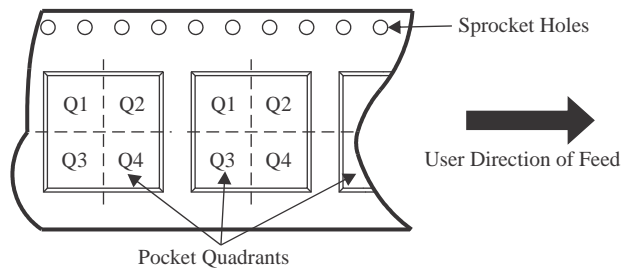
*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
LM317DCYR	SOT-223	DCY	4	2500	330.0	12.4	7.05	7.4	1.9	8.0	12.0	Q3
LM317DCYR	SOT-223	DCY	4	2500	330.0	12.4	6.55	7.25	1.9	8.0	12.0	Q3
LM317KTTR	DDPAK/ TO-263	KTT	3	500	330.0	24.4	10.8	16.1	4.9	16.0	24.0	Q2
LM317KTTR	DDPAK/ TO-263	KTT	3	500	330.0	24.4	10.8	16.3	5.11	16.0	24.0	Q2

TAPE AND REEL BOX DIMENSIONS
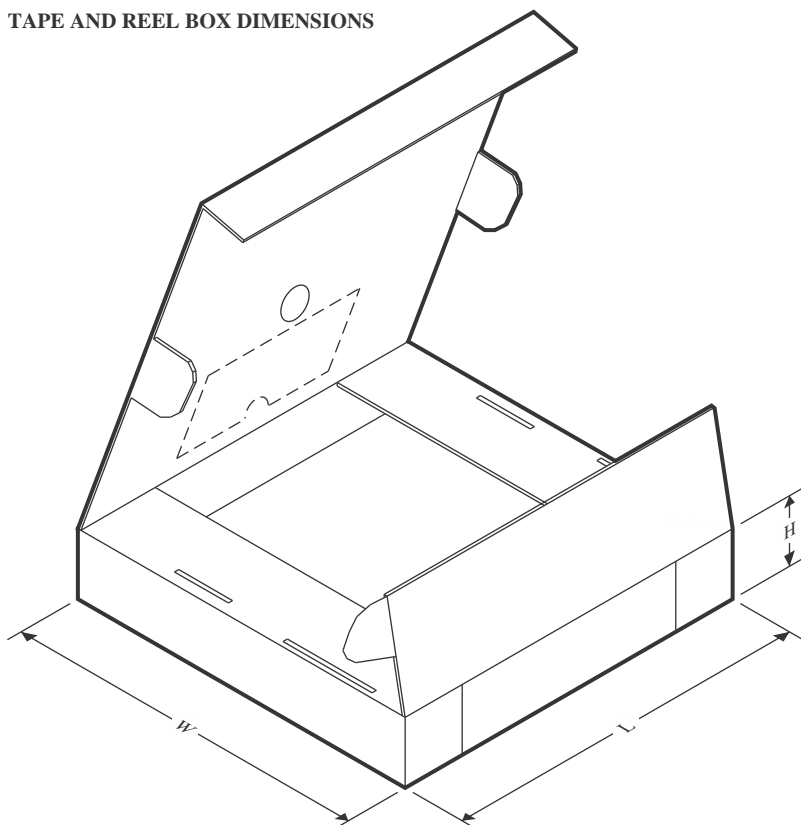
*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
LM317DCYR	SOT-223	DCY	4	2500	340.0	340.0	38.0
LM317DCYR	SOT-223	DCY	4	2500	336.0	336.0	48.0
LM317KTTR	DDPAK/TO-263	KTT	3	500	350.0	334.0	47.0
LM317KTTR	DDPAK/TO-263	KTT	3	500	340.0	340.0	38.0

PACKAGE MATERIALS INFORMATION

TUBE

T - Tube height

L - Tube length

W - Tube width

B - Alignment groove width
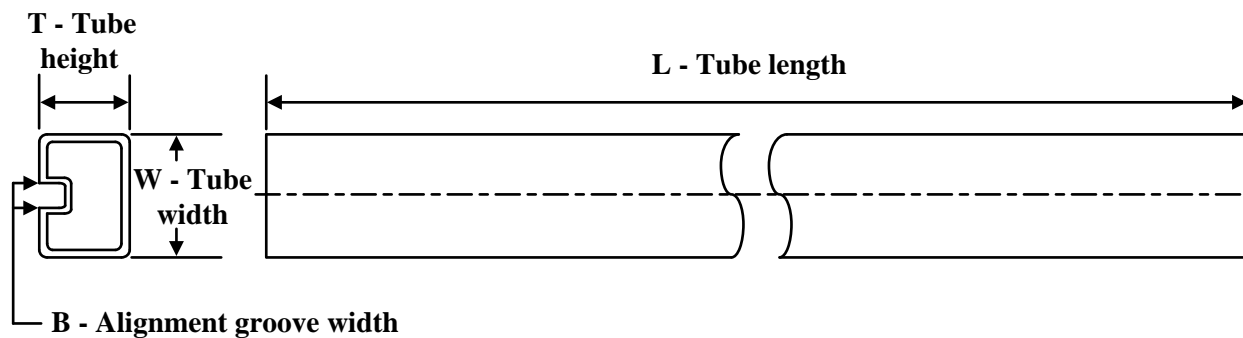
*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (μm)	B (mm)
LM317DCY	DCY	SOT-223	4	80	559	8.6	500	3.6
LM317DCY	DCY	SOT-223	4	80	542.9	8.6	3606	2.67
LM317DCYG3	DCY	SOT-223	4	80	559	8.6	500	3.6
LM317DCYG3	DCY	SOT-223	4	80	542.9	8.6	3606	2.67
LM317KCS	KCS	TO-220	3	50	532	34.1	700	9.6
LM317KCS	KCS	TO-220	3	50	532	34.1	700	9.6
LM317KCSE3	KCS	TO-220	3	50	532	34.1	700	9.6
LM317KCSE3	KCS	TO-220	3	50	532	34.1	700	9.6

DCY (R-PDSO-G4)   **PLASTIC SMALL-OUTLINE**

4202506/B 06/2002
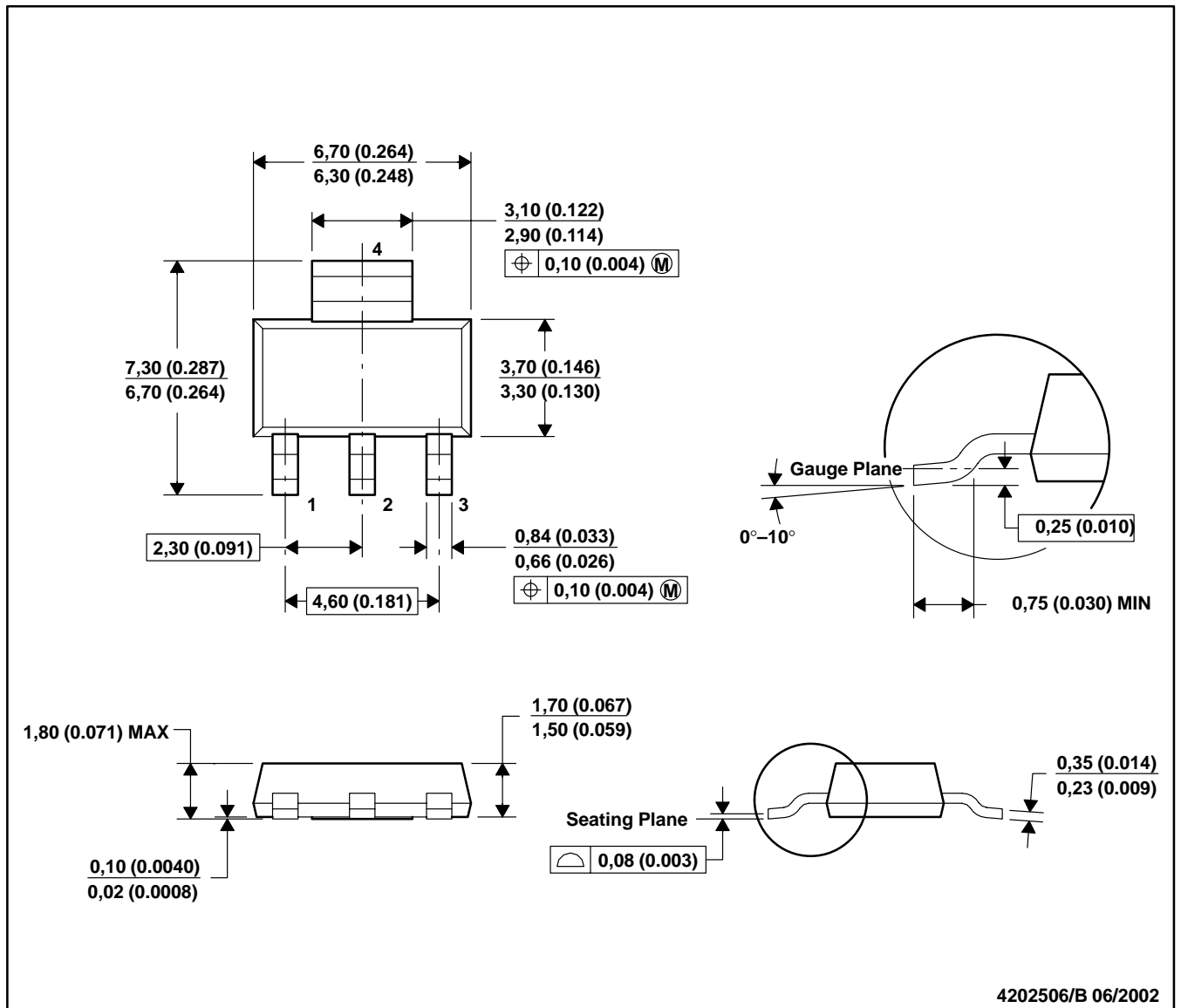
NOTES: A. All linear dimensions are in millimeters (inches).
           B. This drawing is subject to change without notice.
           C. Body dimensions do not include mold flash or protrusion.
           D. Falls within JEDEC TO-261 Variation AA.

DCY (R−PDSO−G4)   PLASTIC SMALL OUTLINE

Example Board Layout

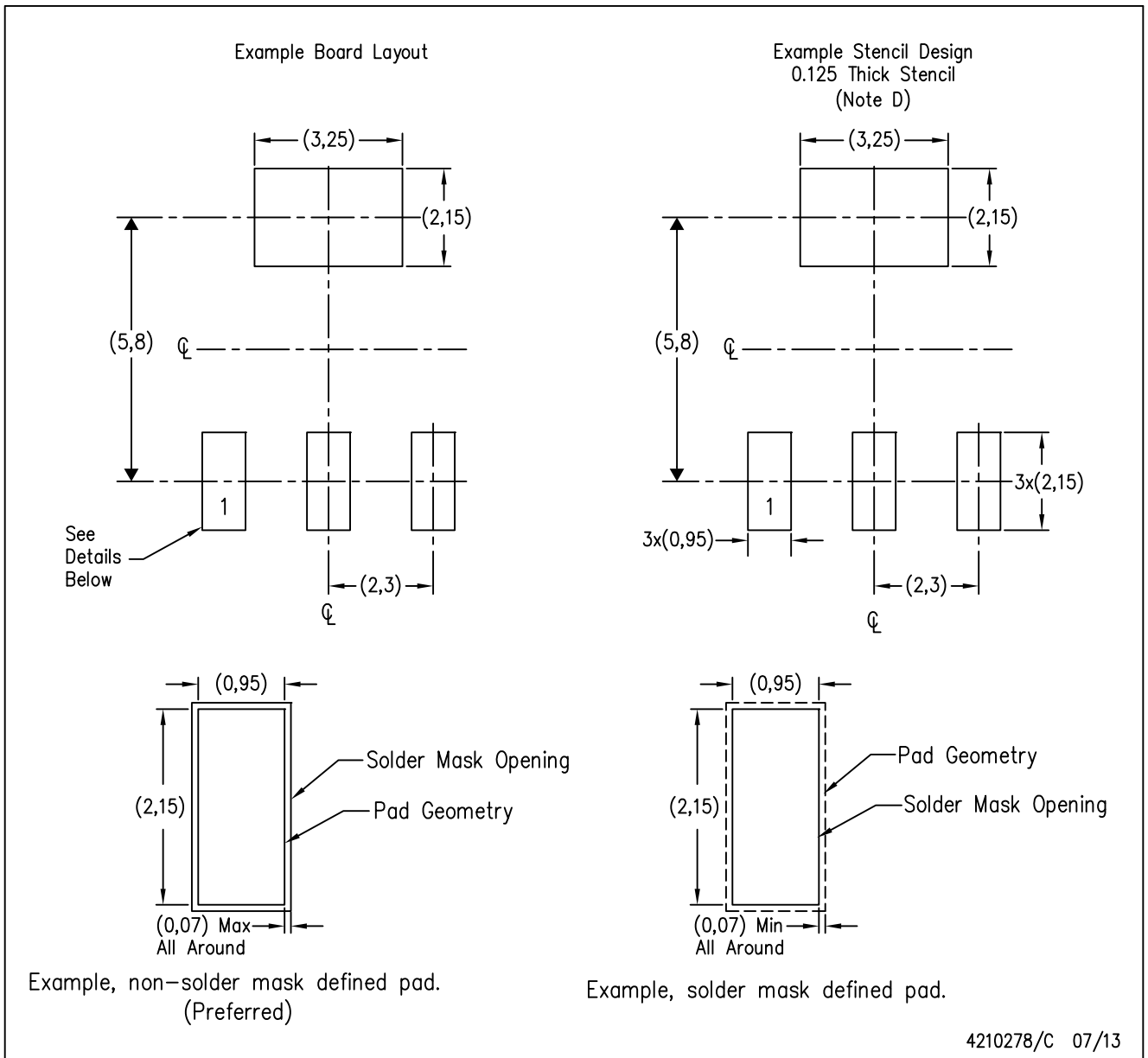Example Stencil Design
0.125 Thick Stencil
(Note D)

← (3,25) →

(2,15)

(5,8)   ℄

1

See
Details
Below

←(2,3)→

℄

← (3,25) →

(2,15)

(5,8)   ℄

1

3x(0,95)→

3x(2,15)

←(2,3)→

℄

→ (0,95) ←

(2,15)

(0,07) Max
All Around

Solder Mask Opening
Pad Geometry

Example, non−solder mask defined pad.
(Preferred)

→ (0,95) ←

(2,15)

(0,07) Min
All Around

Pad Geometry
Solder Mask Opening

Example, solder mask defined pad.

4210278/C 07/13

NOTES: A. All linear dimensions are in millimeters.
          B. This drawing is subject to change without notice.
          C. Publication IPC−7351 is recommended for alternate designs.
          D. Laser cutting apertures with trapezoidal walls and also rounding corners will
              offer better paste release. Customers should contact their board assembly
              site for stencil recommendations. Refer to IPC 7525 for stencil design
              considerations.

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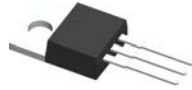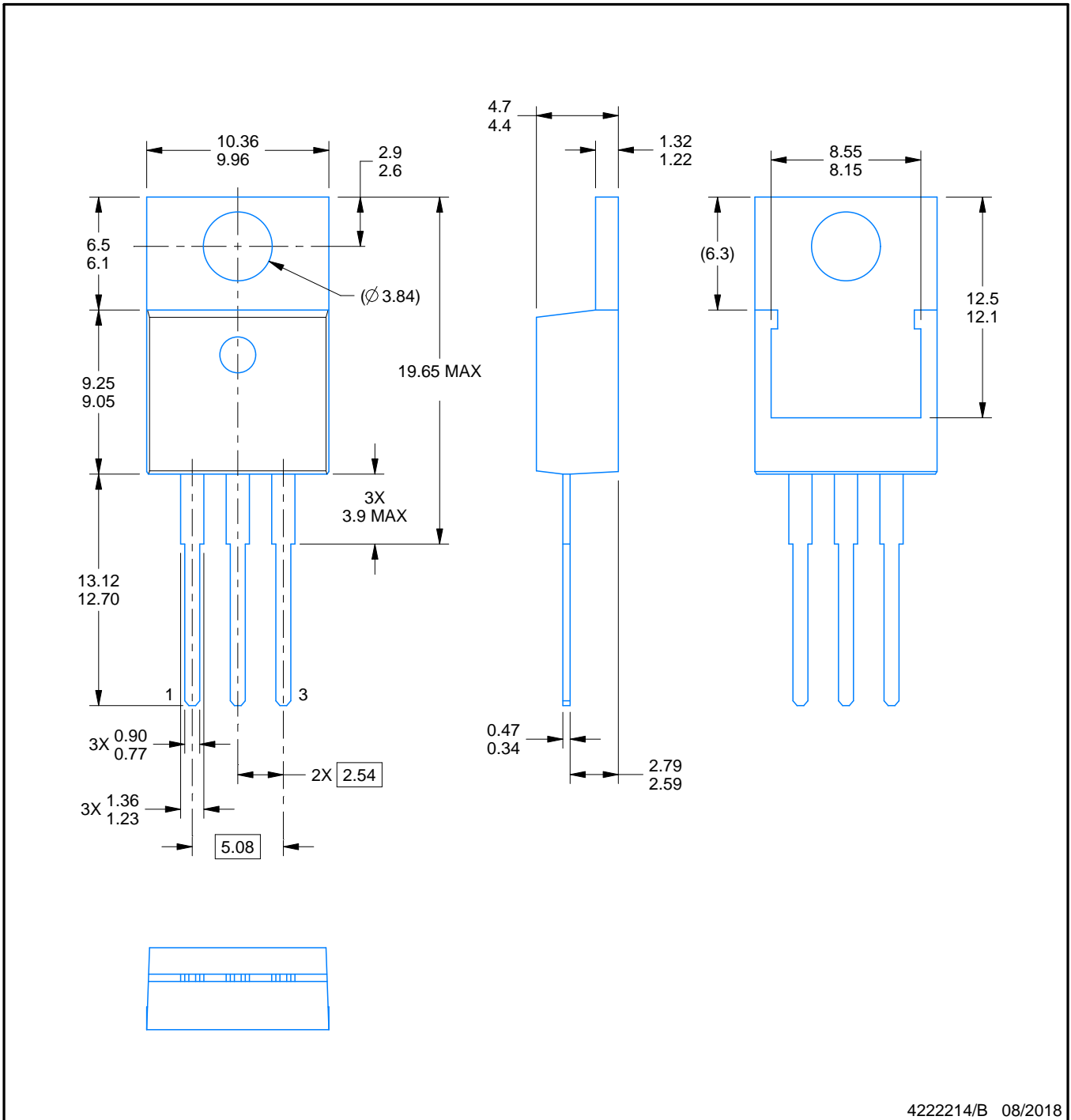
4222214/B   08/2018

NOTES:

1. Dimensions are in millimeters. Any dimension in brackets or parenthesis are for reference only. Dimensioning and tolerancing
   per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. Reference JEDEC registration TO-220.

0.07 MAX
ALL AROUND

3X ⌀ (1.2)

2X ⌀ (1.7)
METAL

2X SOLDER MASK
OPENING

☐ (1.7)

R (0.05)

SOLDER MASK
OPENING

1

2

3

(2.54)

(5.08)

0.07 MAX
ALL AROUND
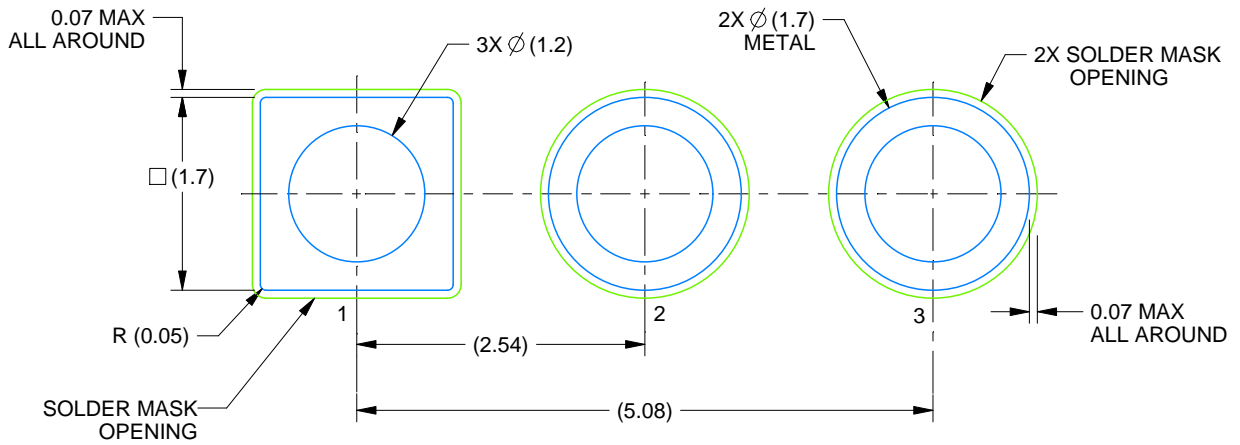
LAND PATTERN EXAMPLE
NON-SOLDER MASK DEFINED
SCALE:15X

4222214/B   08/2018

KTT (R−PSFM−G3)   PLASTIC FLANGE−MOUNT PACKAGE
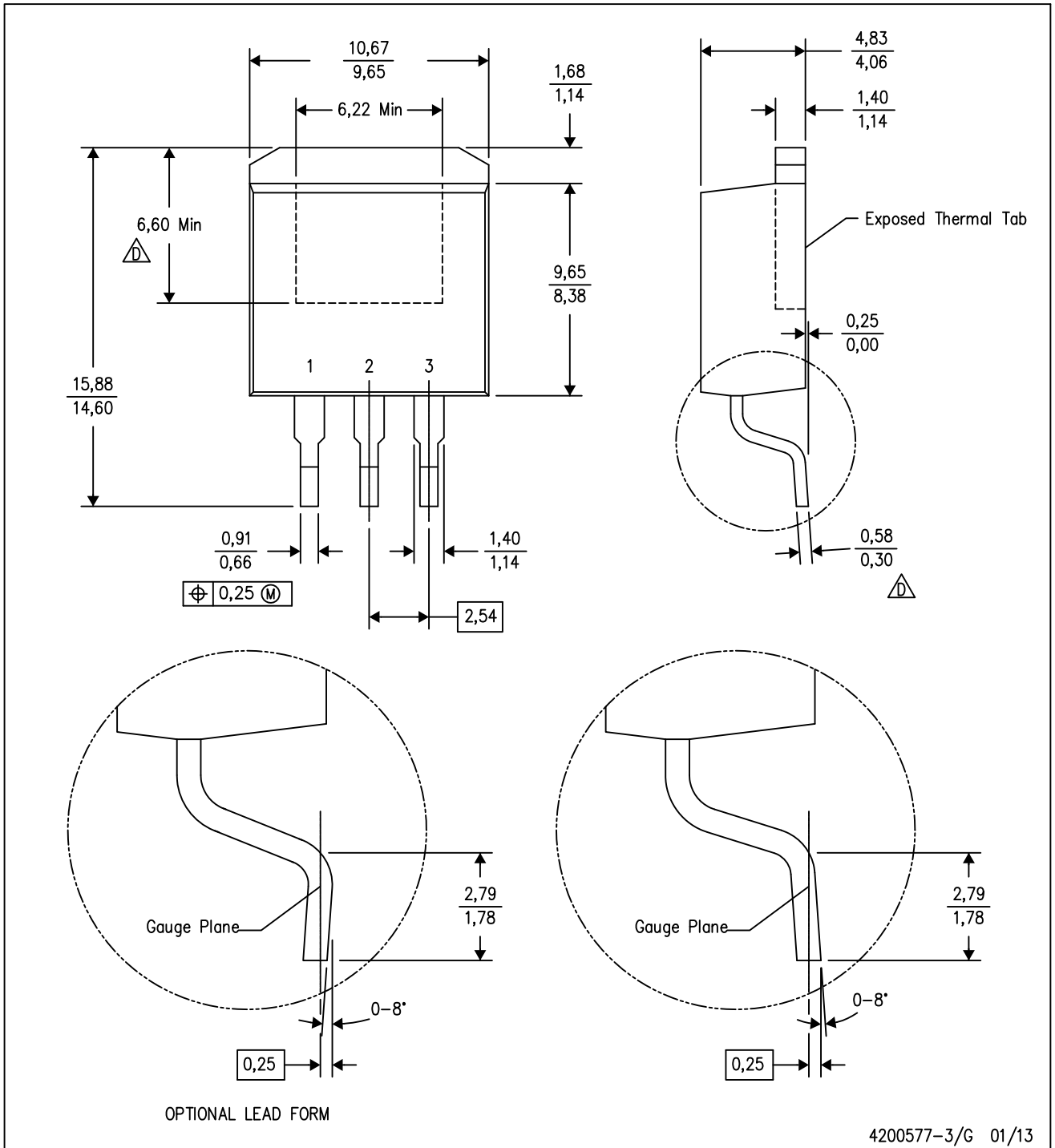
OPTIONAL LEAD FORM

4200577−3/G 01/13

NOTES: A. All linear dimensions are in millimeters.
        B. This drawing is subject to change without notice.
        C. Body dimensions do not include mold flash or protrusion. Mold flash or protrusion not to exceed 0.005 (0,13) per side.
        D. Falls within JEDEC TO−263 variation AA, except minimum lead thickness and minimum exposed pad length.
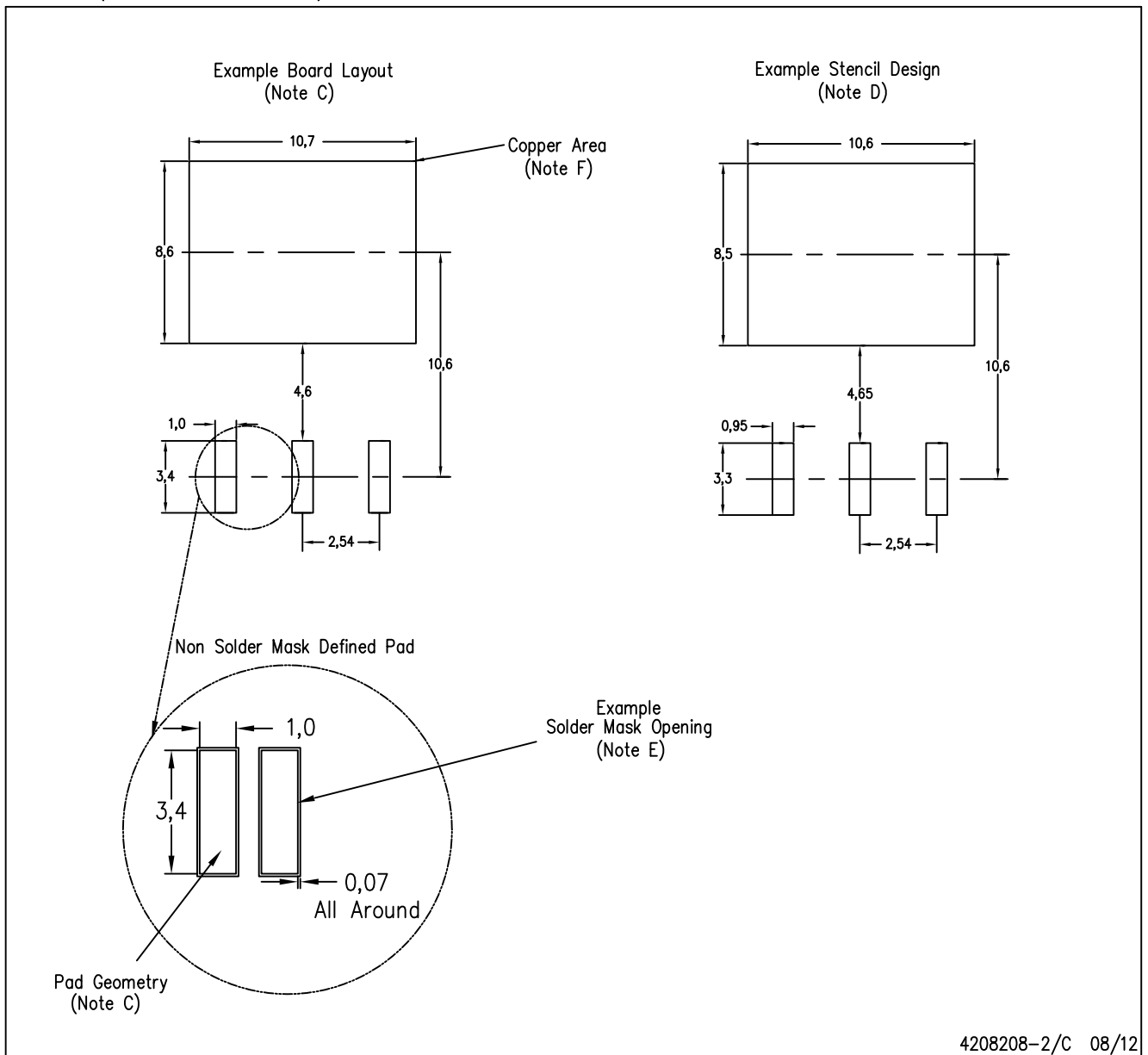
TEXAS
INSTRUMENTS
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KTT (R−PSFM−G3)   PLASTIC FLANGE−MOUNT PACKAGE

Example Board Layout
(Note C)

10,7

Copper Area
(Note F)

8,6

10,6

4,6

1,0

3,4

2,54

Non Solder Mask Defined Pad

1,0

3,4

0,07
All Around

Example
Solder Mask Opening
(Note E)

Pad Geometry
(Note C)

Example Stencil Design
(Note D)

10,6

8,5

10,6

4,65

0,95

3,3

2,54

4208208−2/C 08/12

NOTES: A. All linear dimensions are in millimeters.
        B. This drawing is subject to change without notice.
        C. Publication IPC−SM−782 is recommended for alternate designs.
        D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release.
            Customers should contact their board assembly site for stencil design recommendations. Refer to IPC−7525.
        E. Customers should contact their board fabrication site for solder mask tolerances between and around
            signal pads.
        F. This package is designed to be soldered to a thermal pad on the board. Refer to the Product Datasheet
            for specific thermal information, via requirements, and recommended thermal pad size. For thermal pad
            sizes larger than shown a solder mask defined pad is recommended in order to maintain the solderable
            pad geometry while increasing copper area.

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